R39x and all connectors / headers are Test Interface Parts

**DDR2 & Linears**

1.8V for DDR2

2.5V_S5 ENABLE

1.25V_S5 ENABLE

1.25V_RAM ENABLE

1.05V_RAM ENABLE

1.8V & 5A

1.5V ENABLE

1.05V_RAM ENABLE

1.05V_RAM ENABLE

100mA

2.5V_S5 ENABLE

1.5V ENABLE

1.8V_ENABLE

0.9V_ENABLE

12.1k for Rmode for 670kHz and tracking discharge

1.25V_S0 ENABLE

1.05V_RAM ENABLE
1.05V I/O

1.2V I/O

1.2V & 1.05V

R49x, R69x, C69x and all connectors / headers are Test Interface Ports.
On Board Dynamic Load for CPU, GPU

1. SW701: ON Enable CPU Core Dynamic load
   OFF Disable CPU Core Dynamic load
2. SW702: ON Enable CPU Core Dynamic load
   OFF Disable GPU Core Dynamic load

Note4:
- Not used

All parts on this page are Test Interface Parts

1.3A max

4.5A max

1A max

10mA max

60mA max
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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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